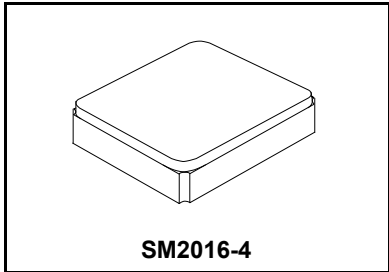


- Low Insertion Loss
- Direct Match to 50 ohms
- 2.0 x 1.6 mm Surface-mount Case
- Complies with Directive 2002/95/EC (RoHS)

RoHS
Compliant

SF2098H

**915 MHz
SAW Filter**



Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+15	dBm
Maximum DC Voltage on any Non-ground Terminal	3	VDC
Operating Temperature Range	-40 to +100	°C
Storage Temperature of Device	-40 to +100	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile (5 cycles maximum)	265°C for 10 s	

Electrical Characteristics (-40 to +85°C only)

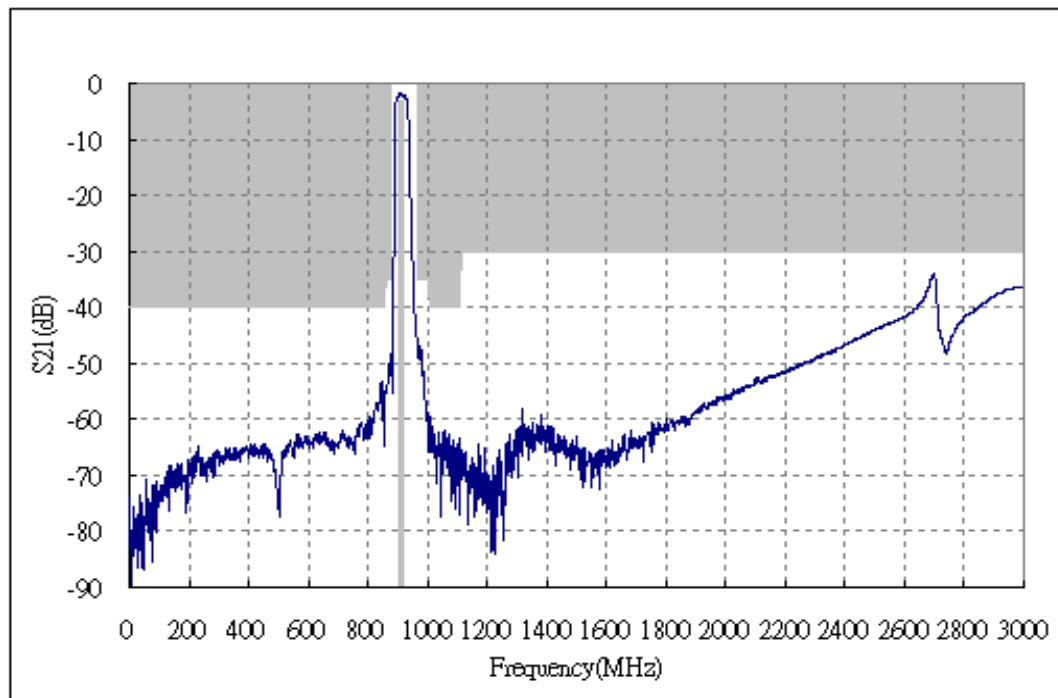
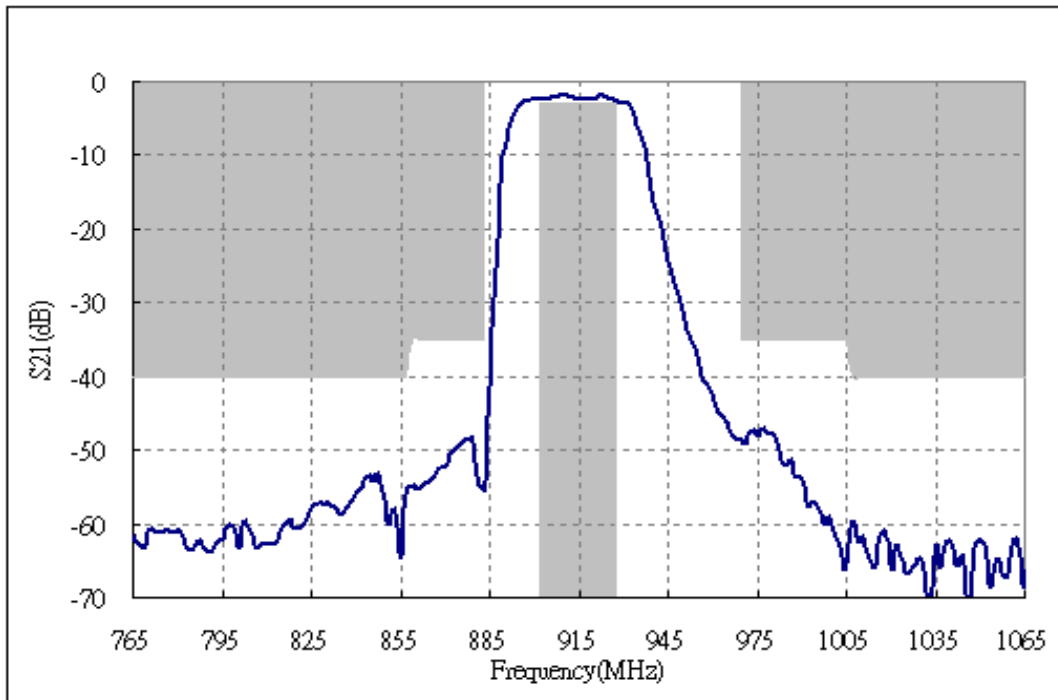
Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C		915			MHz
Insertion Loss, 902 to 928 MHz	IL			2.0	3.0	dB
Amplitude Ripple, Peak-to-Peak, 902 to 928 MHz				0.8	1.5	
Input/Output Return Loss, 902 to 928 MHz				9.5	8.0	
Group Delay Ripple, Peak-to-Peak, 902 to 928 MHz				35	50	ns
Attenuation Referenced to 0 dB:						dB
10 to 857.5 MHz			40	55		
857.5 to 882.5 MHz			35	48		
970 to 1005 MHz			35	48		
1005 to 1110 MHz			45	52		
1110 to 3000 MHz			30	35		
Source impedance	Z_S			50		Ω
Load impedance	Z_L			50		Ω
Single-ended Input / Output Impedance Match	No matching network required for operation at 50 ohms					
Case Style	SM2016-4					
Lid Symbolization (Y=year, W=week)	3H, <u>YW</u>					

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

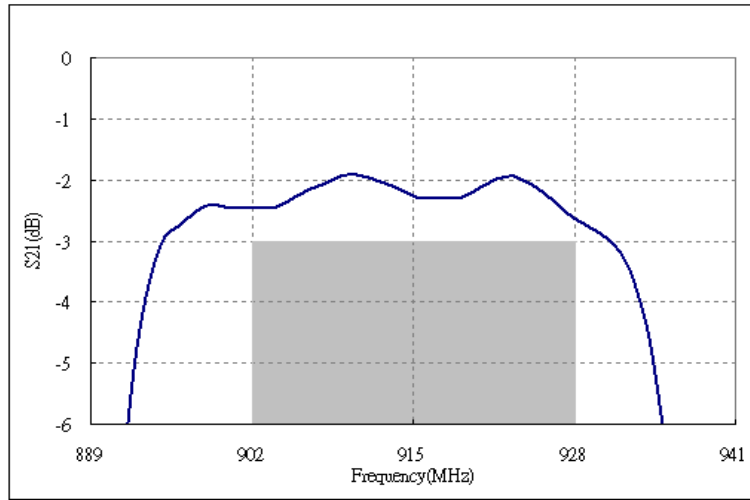
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

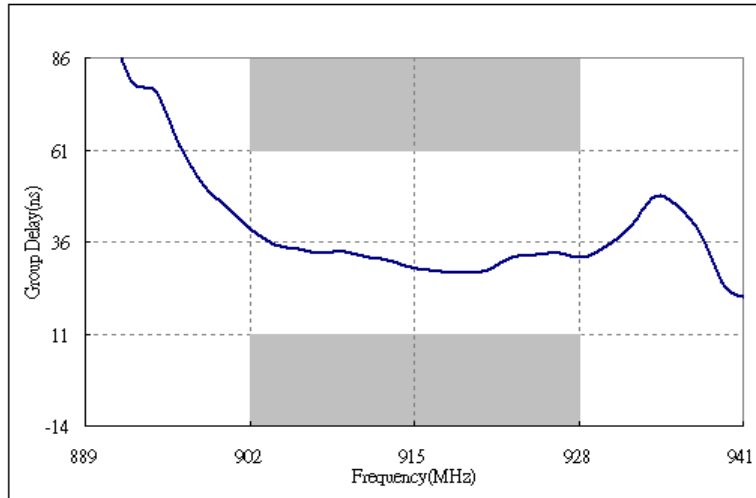
Filter Response Plots



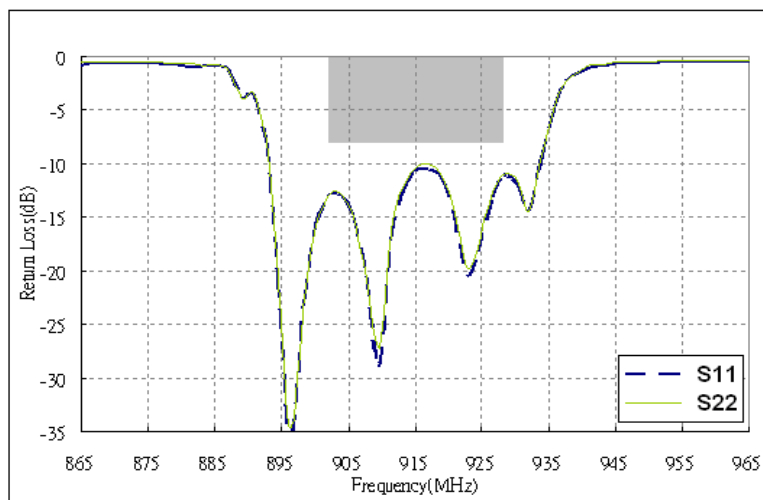
Passband Amplitude Plot



Passband Group Delay Plot

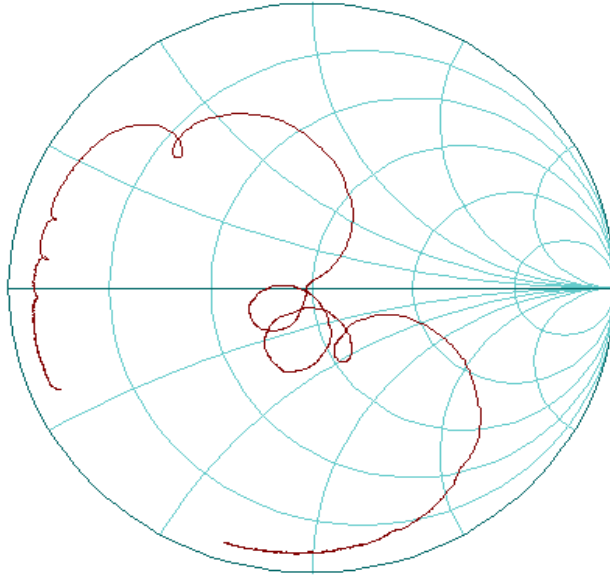


Passband Return Loss Plot

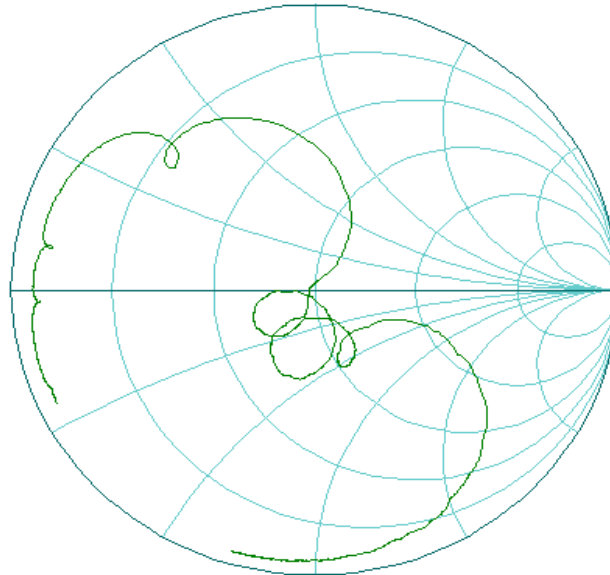


Input and Output Impedance Plots

▶ **S11** Smith (R+jX) Scale 1.000U [F2]

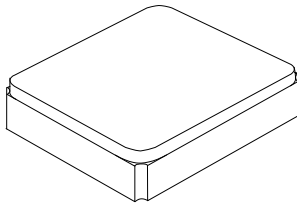


▶ **S22** Smith (R+jX) Scale 1.000U [F2]



SM2016-4 Case

4-Terminal Ceramic Surface-Mount Case 2.0 X 1.6 mm Nominal Footprint

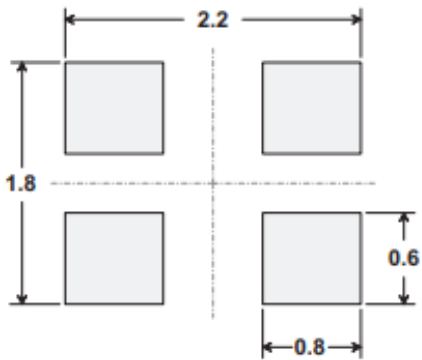


Electrical Connections

Connection	Terminals
Input	1
Output	3
Ground	2, 4

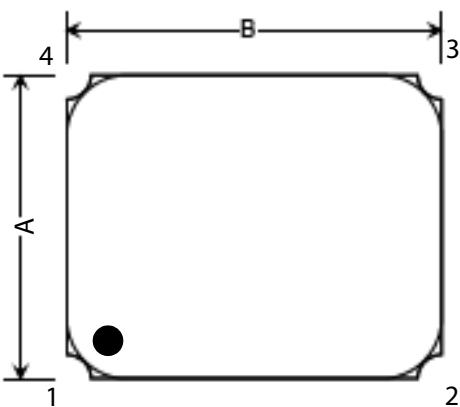
Dimensions	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	1.57	1.60	1.73	0.062	0.063	0.068
B	1.97	2.00	2.13	0.078	0.079	0.084
C	0.55	0.65	0.75	0.021	0.025	0.029
D		0.10			0.004	
E		0.10			0.004	
F	0.57	0.70	0.83	0.022	0.028	0.033
G	0.37	0.50	0.63	0.015	0.020	0.025
H		0.10			0.004	

PCB PAD LAYOUT



Dimensions in mm
All pads have the same dimensions

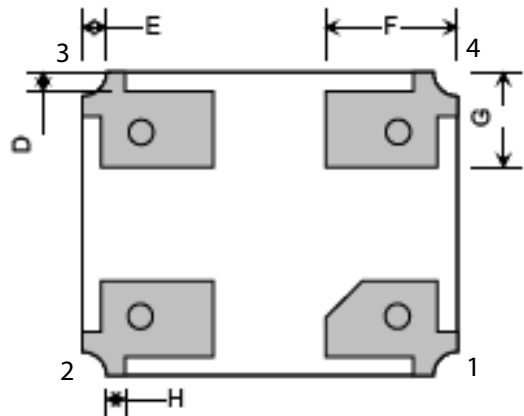
TOP VIEW



SIDE VIEW



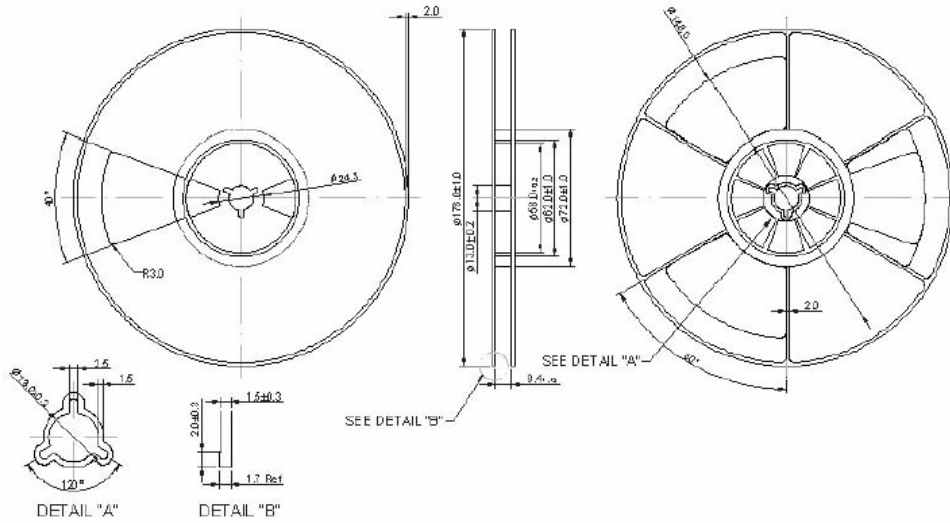
BOTTOM VIEW



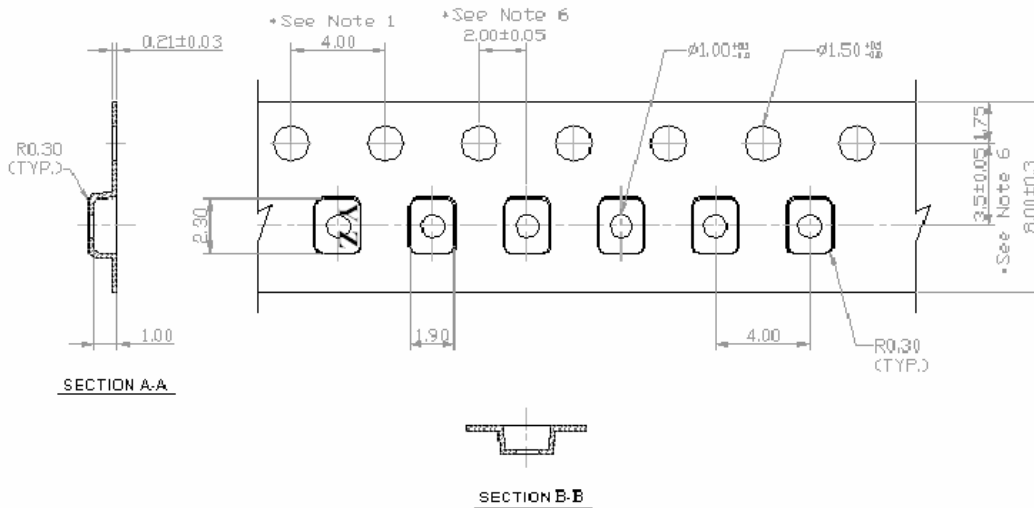
Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

Reel Dimensions



2. TAPE DIMENSION



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C+0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

